



SPECIFICATION (Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL05A226MQ5N6J8

Product : Multi-layer Ceramic Capacitor

Description : CAP, 22 / F, 6.3 V, ±20%, X5R, 0402

A. Samsung Part Number

<u>CL</u> <u>05</u> <u>A</u> <u>226</u> <u>M</u> <u>Q</u> <u>5</u> <u>N</u> <u>6</u> <u>J</u> <u>8</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor		
2	Size	0402 (inch code)	L:1.00 ±0.20 mm	W: 0.50 ± 0.25 mm
3	Dielectric	X5R	8 Inner electrode	Ni
4	Capacitance	22 μF	Termination	Cu
⑤	Capacitance	±20 %	Plating	Sn 100% (Pb Free)
	tolerance		9 Product	Size Control Code
6	Rated Voltage	6.3 V	10 Special	Size Control Code
7	Thickness	0.50 ± 0.25 mm	① Packaging	Cardboard Type, 7" reel

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition
Capacitance	Within specified tolerance	120Hz±20% 0.5±0.1Vrms
Tan δ (DF)	0.15 max.	*A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C for 1 hour and maintained in ambient air for 24±2hours.
Insulation	10,000Mohm or 10Mohm× <i>μ</i> F	Rated Voltage 60~120 sec.
Resistance	Whichever is Smaller	
Appearance No abnormal exterior appearance		Visual inspection
Withstanding	No dielectric breakdown or	250% of the rated voltage
Voltage	mechanical breakdown	
Temperature	X5R	
Characteristics (From -55 °C to 85 °C, Capacitance cha		ge should be within ±15%)
Adhesive Strength No peeling shall be occur on the		500g·F, for 10±1 sec.
of Termination terminal electrode		
Bending Strength	Capacitance change: within ±12.5%	Bending to the limit (1mm)
		with 1.0mm/sec.
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder
	is to be soldered newly	245±5°C, 3±0.3sec.
		(preheating : 80~120 ℃ for 10~30sec.)
Resistance to Capacitance change: within ±15%		Solder pot : 270±5℃, 10±1sec.
Soldering heat Tan δ, IR : initial spec.		

	Performance	Test condition	
Vibration Test Capacitance change: initial spec.		Amplitude : 1.5mm	
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)	
		2hours ´3 direction (x, y, z)	
Moisture	Capacitance change: within ±12.5%	With rated voltage	
Resistance Tan δ: 0.25 max		40±2℃, 90~95%RH, 500+12/-0 hour	
	IR : 500Mohm or 1Mohm × μ F		
	Whichever is Smaller		
High Temperature	Capacitance change: within ±12.5%	With 100% of the rated voltage	
Resistance	Tan δ : 0.25 max	Max. operating temperature	
	IR : 1,000Mohm or 2Mohm × μ F		
	Whichever is Smaller	1000+48/-0 hour	
Temperature	Capacitance change: within ±15%	1 cycle condition	
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25 $^{\circ}$ C	
		$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^{\circ}{\mathbb C}$	
		5 cycles test	

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)



A Product specifications included in the specifications are effective as of March 1, 2014. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.